

ON Semiconductor®

## FFSH30120ADN-F155

# Silicon Carbide Schottky Diode 1200 V, 30 A

#### **Features**

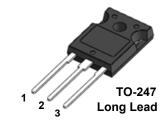
- Max Junction Temperature 175 °C
- · Avalanche Rated 145 mJ
- · High Surge Current Capacity
- · Positive Temperature Coefficient
- · Ease of Paralleling
- · No Reverse Recovery / No Forward Recovery

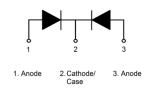
## **Applications**

- · General Purpose
- · SMPS, Solar Inverter, UPS
- · Power Switching Circuits

## **Description**

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.





### **Absolute Maximum Ratings** T<sub>C</sub> = 25 °C unless otherwise noted. (per leg)

| Symbol                            | Parameter                                                               |                                          | FFSH30120ADN-F155 | Unit |
|-----------------------------------|-------------------------------------------------------------------------|------------------------------------------|-------------------|------|
| $V_{RRM}$                         | Peak Repetitive Reverse Voltage                                         |                                          | 1200              | V    |
| E <sub>AS</sub>                   | Single Pulse Avalanche Energy                                           | (Note 1)                                 | 145               | mJ   |
| I <sub>F</sub>                    | Continuous Rectified Forward Current @ 1                                | 「c < 148 °C                              | 15* / 30**        | Α    |
| 1                                 | Non-Repetitive Peak Forward Surge Current                               | T <sub>C</sub> = 25 °C, 10 μs            | 1030              | Α    |
| IF, Max                           |                                                                         | T <sub>C</sub> = 150 °C, 10 μs           | 990               | Α    |
| I <sub>F,SM</sub>                 | Non-Repetitive Forward Surge Current                                    | Half-Sine Pulse, t <sub>p</sub> = 8.3 ms | 125               | Α    |
| I <sub>F,RM</sub>                 | Repetitive Forward Surge Current                                        | Half-Sine Pulse, t <sub>p</sub> = 8.3 ms | 50                | Α    |
| Ptot                              | Dower Dissipation                                                       | T <sub>C</sub> = 25 °C                   | 195               | W    |
| Fioi                              | Power Dissipation                                                       | T <sub>C</sub> = 150 °C                  | 32                | W    |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range TO247 Mounting Torque, M3 Screw |                                          | -55 to +175       | °C   |
|                                   |                                                                         |                                          | 60                | Ncm  |

#### **Thermal Characteristic**

| Symbol          | Parameter                                 | FFSH30120ADN-F155 | Unit |
|-----------------|-------------------------------------------|-------------------|------|
| $R_{\theta,IC}$ | Thermal Resistance, Junction to Case, Max | 0.77* / 0.32**    | °C/W |

<sup>\*</sup> Per leg, \*\* Per Device

### **Package Marking and Ordering Information**

| Part Number       | Top Mark     | Package          | Packing Method | Reel Size | Tape Width | Quantity |  |
|-------------------|--------------|------------------|----------------|-----------|------------|----------|--|
| FFSH30120ADN-F155 | FFSH30120ADN | TO-247 Long Lead | Tube           | N/A       | N/A        | 30 units |  |

## **Electrical Characteristics** T<sub>C</sub> = 25 °C unless otherwise noted. (per leg)

| Symbol         | Parameter               | Test Conditions                                    | Min. | Тур. | Max. | Unit |
|----------------|-------------------------|----------------------------------------------------|------|------|------|------|
|                |                         | I <sub>F</sub> = 15 A, T <sub>C</sub> = 25 °C      | -    | 1.45 | 1.75 |      |
| V <sub>F</sub> | Forward Voltage         | I <sub>F</sub> = 15 A, T <sub>C</sub> = 125 °C     | -    | 1.7  | 2    | V    |
|                |                         | I <sub>F</sub> = 15 A, T <sub>C</sub> = 175 °C     | -    | 2    | 2.4  |      |
| I <sub>R</sub> | Reverse Current         | $V_R = 1200 \text{ V}, T_C = 25  ^{\circ}\text{C}$ | -    | -    | 200  | μА   |
|                |                         | $V_R = 1200 \text{ V}, T_C = 125 ^{\circ}\text{C}$ | -    | -    | 300  |      |
|                |                         | $V_R = 1200 \text{ V}, T_C = 175 ^{\circ}\text{C}$ | -    | -    | 400  |      |
| $Q_C$          | Total Capacitive Charge | V = 800 V                                          | -    | 95   | -    | nC   |
| С              |                         | V <sub>R</sub> = 1 V, f = 100 kHz                  | -    | 936  | -    |      |
|                | Total Capacitance       | $V_R = 400 \text{ V}, f = 100 \text{ kHz}$         | -    | 86   | -    | pF   |
|                |                         | $V_R = 800 \text{ V}, f = 100 \text{ kHz}$         | -    | 68   | -    |      |

## Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted (per leg).

Figure 1. Forward Characteristics

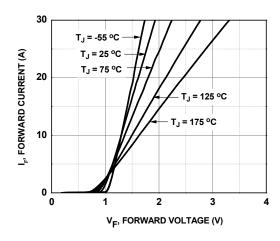


Figure 3. Reverse Characteristics

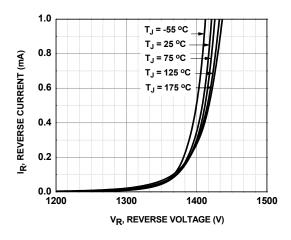


Figure 2. Reverse Characteristics

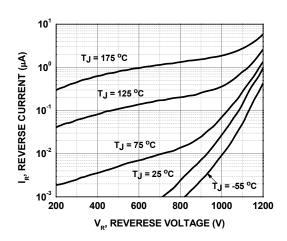
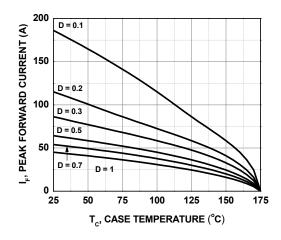


Figure 4. Current Derating



Notes: 1: EAS of 145 mJ is based on starting  $T_J$  = 25 °C, L = 0.5 mH,  $I_{AS}$  = 24 A, V = 150 V.

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted (per leg, continue).

Figure 5. Power Derating

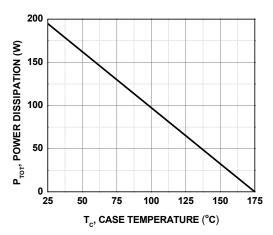


Figure 7. Capacitance vs. Reverse Voltage

100 80 60

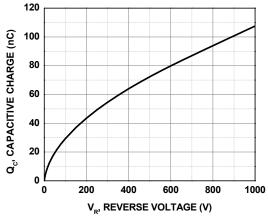
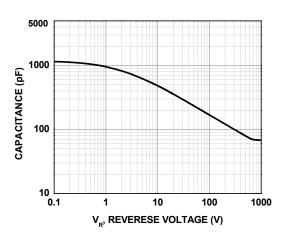


Figure 6. Capacitive Charge vs.

Reverse Voltage

Figure 8. Capacitance Stored Energy



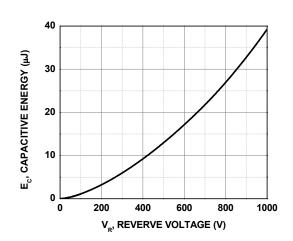
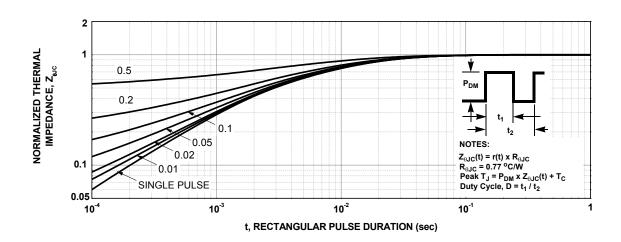
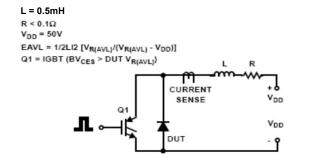


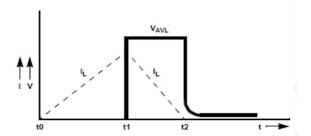
Figure 9. Junction-to-Case Transient Thermal Response Curve



## **Test Circuit and Waveforms**

Figure 10. Unclamped Inductive Switching Test Circuit & Waveform





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